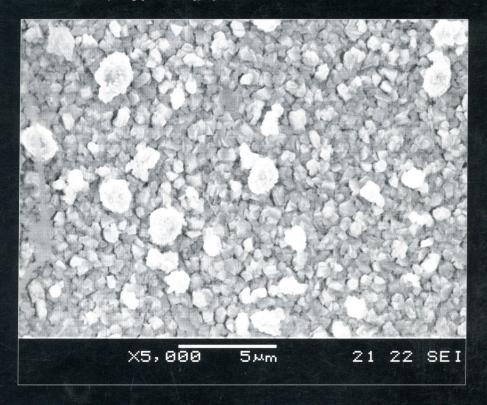
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Number 1

Volume 36

compound materialsM L Chenene and V Alberts

7 January 2003

	RAPID COMMUNICATIONS
L1	Stratospheric discharges during solar gamma flares A V Moldavanov
L5	Nanoindentation of Si, GaP, GaAs and ZnSe single crystals S E Grillo, M Ducarroir, M Nadal, E Tournié and J-P Faurie
L10	Anisotropy properties of magnetic colloidal materials Y Qi, L Zhang and W Wen
L15	Large acoustic band gaps created by rotating square rods in two-dimensional periodic composites X Li, F Wu, H Hu, S Zhong and Y Liu
L18	Temperature dependence of emission frequency spectra of a liquid metal anode Ch Akhmadaliev, L Bischoff, G L R Mair, C J Aidinis, Th Ganetsos and E Anagnostakis
	PAPERS
	APPLIED MAGNETISM, MAGNETIC MATERIALS AND SUPERCONDUCTIVITY
1	The effect of Mn substitution in LaFe _{11.7} Si _{1.3} compound on the magnetic properties and magnetic entropy changes F Wang, Y-F Chen, G-J Wang and B-G Shen
4	Effect of Ta on magnetic thicknesses of permalloy (Ni ₈₁ Fe ₁₉) films G H Yu, T Yang, F W Zhu, M H Li and W Y Lai
	PHOTONICS AND SEMICONDUCTOR DEVICE PHYSICS
9	Power extraction problem in the externally pumped 16 μm gasdynamic lasers: modelling and optimization A R Bahrampour and R-M Farrahi
	EXPERIMENTAL, COMPUTATIONAL AND THEORETICAL PARTICLE BEAM AND PLASMA SCIENCE
19	Computer modelling of a short-pulse excited dielectric barrier discharge xenon excimer lamp ($\lambda\sim 172$ nm) R J Carman and R P Mildren
34	Joining active plasma and sheath when the plasma contains two species of positive ions R N Franklin
39	Modelling of the homogeneous barrier discharge in helium at atmospheric pressure Yu B Golubovskii, V A Maiorov, J Behnke and J F Behnke
	APPLIED SURFACES AND INTERFACES
50	Axisymmetric indentation of an incompressible elastic thin film F Yang
56	Structural and compositional properties of Cu(In,Ga)Se ₂ thin films prepared by the thermal evaporation of